

# LP2992 Micropower 250 mA Low-Noise Ultra Low-Dropout Regulator in SOT-23 and WSON Packages Designed for Use with Very Low ESR Output Capacitors

Check for Samples: LP2992

#### **FEATURES**

- Ultra Low Dropout Voltage
- Specified 250 mA Output Current
- Smallest Possible Size (SOT-23, WSON Package)
- Requires Minimum External Components
- Stable with Low-ESR Output Capacitor
- <1 µA Quiescent Current when Shut Down</li>
- Low Ground Pin Current at all Loads
- Output Voltage Accuracy 1% (A Grade)
- High Peak Current Capability
- Wide Supply Voltage Range (16V Max)
- Low Z<sub>OUT</sub>: 0.3Ω Typical (10 Hz to 1 MHz)
- Overtemperature/overcurrent Protection
- -40°C to +125°C Junction Temperature Range
- Custom Voltages Available

#### **APPLICATIONS**

- Cellular Phone
- Palmtop/Laptop Computer
- Personal Digital Assistant (PDA)
- · Camcorder, Personal Stereo, Camera

#### DESCRIPTION

The LP2992 is a 250 mA, fixed-output voltage regulator designed to provide ultra low-dropout and low noise in battery powered applications.

Using an optimized VIP (Vertically Integrated PNP) process, the LP2992 delivers unequaled performance in all specifications critical to battery-powered designs:

**Dropout Voltage:** Typically 450 mV @ 250 mA load, and 5 mV @ 1 mA load.

**Ground Pin Current:** Typically 1500  $\mu$ A @ 250 mA load, and 75  $\mu$ A @ 1 mA load.

**Enhanced Stability:** The LP2992 is stable with output capacitor ESR as low as  $5 \text{ m}\Omega$ , which allows the use of ceramic capacitors on the output.

**Sleep Mode:** Less than 1 μA quiescent current when ON/OFF pin is pulled low.

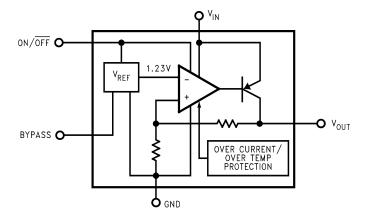
**Smallest Possible Size:** SOT-23 and WSON packages use absolute minimum board space.

**Precision Output:** 1% tolerance output voltages available (A grade).

**Low Noise:** By adding a 10 nF bypass capacitor, output noise can be reduced to 30  $\mu$ V (typical).

Multiple voltage options, from 1.5V to 5.0V, are available as standard products. Consult factory for custom voltages.

#### **Block Diagram**

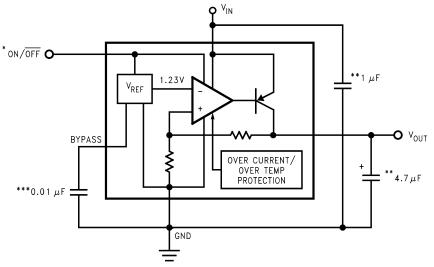


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#### **Basic Application Circuit**



<sup>\*</sup>ON/OFF input must be actively terminated. Tie to  $V_{\text{IN}}$  if this function is not to be used.

#### **Connection Diagram**

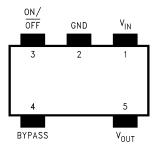


Figure 1. Top View 5-Lead SOT-23 (DBV) See Package Number DBV0005A

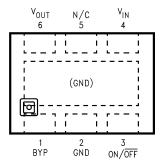


Figure 2. Top View 6-Lead WSON Package (NGD) See Package Number NGD0006A

<sup>\*\*</sup>Minimum capacitance is shown to ensure stability (may be increased without limit). Ceramic capacitor required for output (see Application Hints).

<sup>\*\*\*</sup>Reduces output noise (may be omitted if application is not noise critical). Use ceramic or film type with very low leakage current (see Application Hints).





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings (1)(2)

Absolute maximum ratings	
Storage Temperature Range	-65°C to +150°C
Operating Junction Temperature Range	-40°C to +125°C
Lead Temp. (Soldering, 5 sec.)	260°C
ESD Rating (3)	2 kV
Power Dissipation <sup>(4)</sup>	Internally Limited
Input Supply Voltage (Survival)	-0.3V to +16V
Input Supply Voltage (Operating)	2.2V to +16V
Shutdown Input Voltage (Survival)	-0.3V to +16V
Output Voltage (Survival, <sup>(5)</sup> )	-0.3V to +9V
I <sub>OUT</sub> (Survival)	Short Circuit Protected
Input-Output Voltage (Survival, <sup>(6)</sup> )	-0.3V to +16V
I <sub>OUT</sub> (Survival)	Short Circuit Prote

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the component may occur. Electrical specifications do not apply when operating the device outside of its rated operating conditions.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) The ESD rating of pins 3 and 4 for the SOT-23 package, or pins 1 and 3 for the WSON package, is 1 kV.
- The maximum allowable power dissipation is a function of the maximum junction temperature, T<sub>J</sub>(MAX), the junction-to-ambient thermal resistance, θ<sub>J-A</sub>, and the ambient temperature, T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is calculated using:
  P(MAX) = T<sub>J</sub>(MAX) T<sub>A</sub>

Where the value of  $\theta_{\text{J-A}}$  for the SOT-23 package is 220°C/W in a typical PC board mounting and the WSON package is 65°C/W. Exceeding the maximum allowable dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown.

- (5) If used in a dual-supply system where the regulator load is returned to a negative supply, the LP2992 output must be diode-clamped to ground
- (6) The output PNP structure contains a diode between the V<sub>IN</sub> to V<sub>OUT</sub> terminals that is normally reverse-biased. Reversing the polarity from V<sub>IN</sub> to V<sub>OUT</sub> will turn on this diode.

#### **Electrical Characteristics**

Limits in standard typeface are for  $T_J = 25^{\circ}$ C. and limits in **boldface type** apply over the full operating temperature range. Unless otherwise specified:  $V_{IN} = V_O(NOM) + 1V$ ,  $I_I = 1$  mA,  $C_{IN} = 1$   $\mu$ F,  $C_{OUT} = 4.7$   $\mu$ F,  $V_{ON/OFF} = 2V$ .

				LP299	2AI-X.X	LP299	92I-X.X	
Symbol	Parameter	Conditions	Тур		(1)		Units	
				Min	Max	Min	Max	
$\Delta V_{O}$	Output Voltage	I <sub>L</sub> = 1 mA		-1.0	1.0	-1.5	1.5	
	Tolerance	1 mA ≤ I <sub>L</sub> ≤ 50 mA		<b>−</b> 1.5	1.5	-2.5	2.5	
				-2.5	2.5	-3.5	3.5	%V <sub>NOM</sub>
		1 mA ≤ I <sub>L</sub> ≤ 250 mA		-3.5	3.5	-4.0	4.0	
				-4.5	4.5	-5.0	5.0	
$\Delta V_{O}/\Delta V_{IN}$	Output Voltage	$V_O(NOM)+1V \le V_{IN} \le 16V$	0.007		0.014		0.014	0/ /\/
	Line Regulation				0.032		0.032	%/V
V <sub>IN</sub> (min)	Minimum input voltage required to maintain output regulation		2.05		2.20		2.20	V

Limits are 100% production tested at 25°C. Limits over the operating temperature range are specified through correlation using Statistical Quality Control (SQC) methods. The limits are used to calculate Tl's Average Outgoing Quality Level (AOQL).



#### **Electrical Characteristics (continued)**

Limits in standard typeface are for  $T_J$  = 25°C. and limits in **boldface type** apply over the full operating temperature range. Unless otherwise specified:  $V_{IN} = V_O(NOM) + 1V$ ,  $I_L$  = 1 mA,  $C_{IN}$  = 1  $\mu$ F,  $C_{OUT}$  = 4.7  $\mu$ F,  $V_{ON/OFF}$  = 2V.

					2AI-X.X	LP29		
Symbol	Parameter	Conditions	Тур		(1)		(1)	Units
·				Min	Max	Min	Max	1
V <sub>IN</sub> -V <sub>O</sub>	Dropout Voltage	$I_L = 0$	0.5		2.5		2.5	
	(2)				4		4	
		I <sub>L</sub> = 1 mA	5		9		9	
					12		12	
		$I_L = 50 \text{ mA}$	100		125		125	
					180		180	mV
		I <sub>L</sub> = 150 mA	260		325		325	1
					470		470	
		I <sub>L</sub> = 250 mA	450		575		575	
					850		850	
I <sub>GND</sub>	Ground Pin Current	$I_L = 0$	65		95		95	
					125		125	
		I <sub>L</sub> = 1 mA	75		110		110	
					170		170	
		$I_L = 50 \text{ mA}$	350		600		600	
					1000		1000	
		I <sub>L</sub> = 150 mA	850		1500		1500	μA
					2500		2500	
		I <sub>L</sub> = 250 mA	1500		2300		2300	
					4000		4000	
		V <sub>ON/OFF</sub> < 0.3V	0.01		0.8		0.8	
		V <sub>ON/OFF</sub> < 0.15V	0.05		2		2	
V <sub>ON/OFF</sub>	ON/OFF Input Voltage	High = O/P ON	1.4	1.6		1.6		V
	(0)	Low = O/P OFF	0.55		0.15		0.15	•
I <sub>ON/OFF</sub>	ON/OFF Input Current	$V_{ON/OFF} = 0$	0.01		-2		-2	μA
		$V_{ON/OFF} = 5V$	5		15		15	μΛ
e <sub>n</sub>	Output Noise	BW = 300  Hz to  50  kHz,						
	Voltage (RMS)	$C_{OUT} = 10 \mu F$	30					μV
		C <sub>BYPASS</sub> = 10 nF						
$\Delta V_{OUT}/\Delta V_{IN}$	Ripple Rejection	$f = 1 \text{ kHz}, C_{BYPASS} = 10 \text{ nF}$	45					dB
		$C_{OUT} = 10 \mu F$	40					ub.
I <sub>O</sub> (SC)	Short Circuit Current	t R <sub>L</sub> = 0 (Steady State)						mA
I <sub>O</sub> (PK)	Peak Output Current	$V_{OUT} \ge V_o(NOM) -5\%$	350					mA
J. ,					1	1		

<sup>(2)</sup> V<sub>IN</sub> must be the greater of 2.2V or V<sub>OUT(nom)</sub> + Dropout Voltage to maintain output regulation. Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below the value measured with a 1V differential.

(3) The ON/OFF input must be properly driven to prevent possible misoperation. For details, refer to Application Hints.

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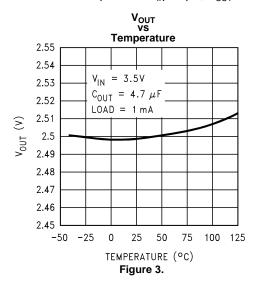
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The LP2992 has foldback current limiting which allows a high peak current when V<sub>OUT</sub> > 0.5V, and then reduces the maximum output current as V<sub>OUT</sub> is forced to ground (see Typical Performance Characteristics curves).



#### **Typical Performance Characteristics**

Unless otherwise specified:  $C_{IN} = 1 \mu F$ ,  $C_{OUT} = 4.7 \mu F$ ,  $V_{IN} = V_{OUT}(NOM) + 1$ ,  $T_A = 25$ °C, ON/OFF pin is tied to  $V_{IN}$ .



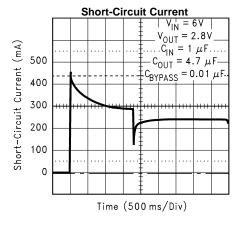
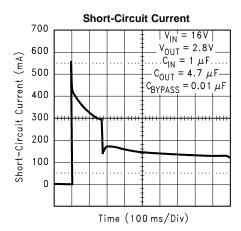


Figure 4.



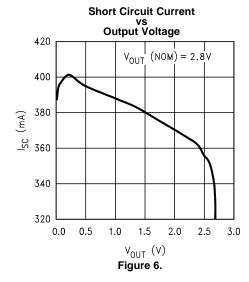
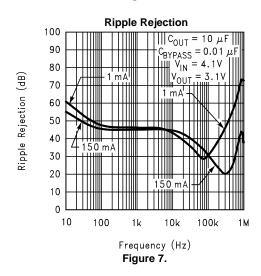
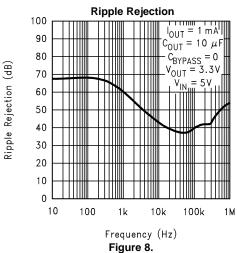


Figure 5.

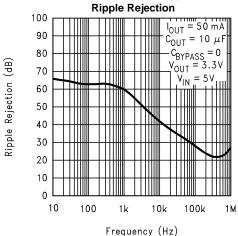




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Unless otherwise specified:  $C_{IN}$  = 1 $\mu$ F,  $C_{OUT}$  = 4.7 $\mu$ F,  $V_{IN}$  =  $V_{OUT}$ (NOM) +1,  $T_A$  = 25°C, ON/OFF pin is tied to  $V_{IN}$ .



Frequency (Hz)
Figure 9.

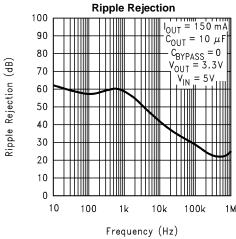


Figure 10.

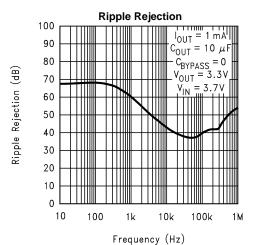
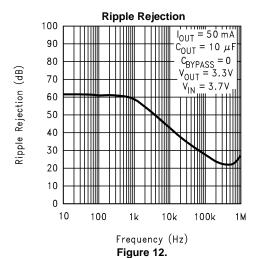


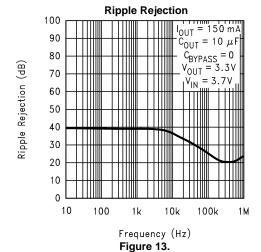
Figure 11.



Ripple Rejection

100

90



80 Ripple Rejection (dB) 70 60 50 40 30 20 50 mA 10 0 10 100 1k 10k 100k Frequency (Hz)

Figure 14.



Unless otherwise specified:  $C_{IN} = 1 \mu F$ ,  $C_{OUT} = 4.7 \mu F$ ,  $V_{IN} = V_{OUT}(NOM) + 1$ ,  $T_A = 25$ °C, ON/OFF pin is tied to  $V_{IN}$ .

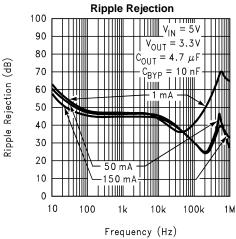


Figure 15.

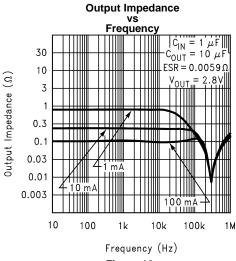


Figure 16.

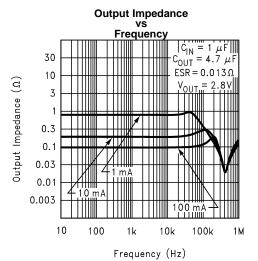


Figure 17.

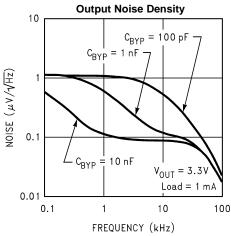
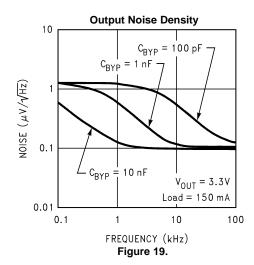
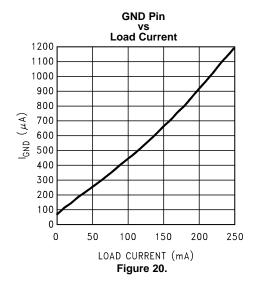


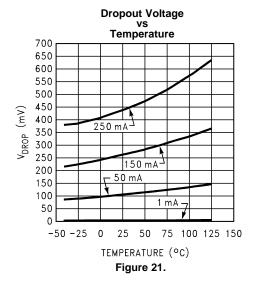
Figure 18.

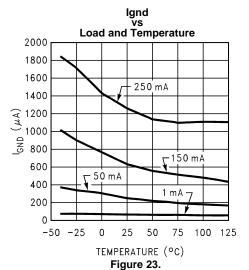


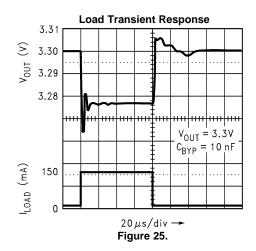


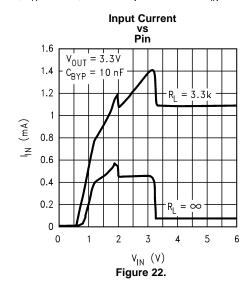


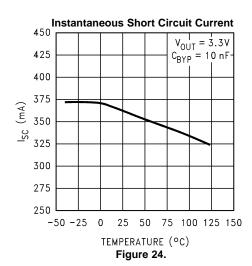
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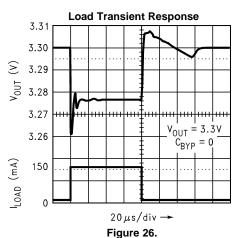














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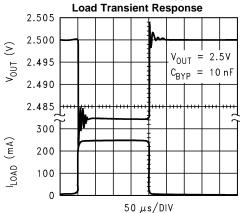


Figure 27.

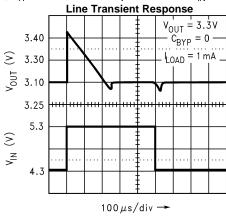


Figure 28.

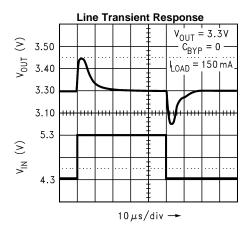


Figure 29.

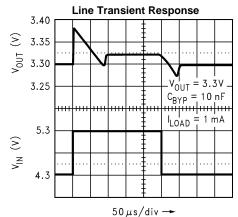
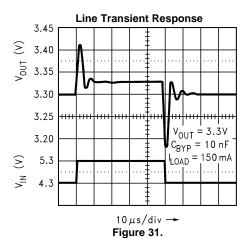
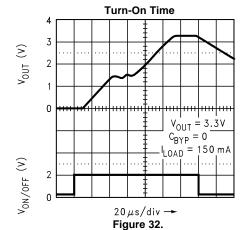


Figure 30.

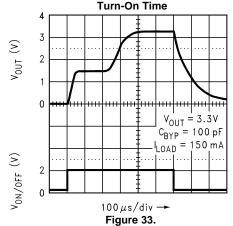


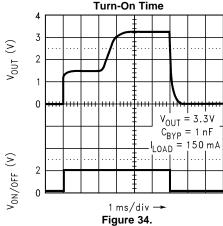


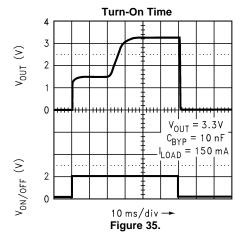
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#### **APPLICATION HINTS**

#### **EXTERNAL CAPACITORS**

Like any low-dropout regulator, the LP2992 requires external capacitors for regulator stability. These capacitors must be correctly selected for good performance.

#### **Input Capacitor**

An input capacitor whose capacitance is  $\geq 1 \, \mu F$  is required between the LP2992 input and ground (the amount of capacitance may be increased without limit).

This capacitor must be located a distance of not more than 1 cm from the input pin and returned to a clean analog ground. Any good quality ceramic, tantalum, or film capacitor may be used at the input.

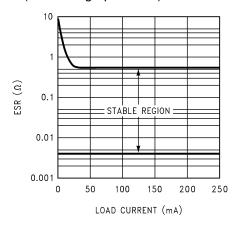
**Important:** Tantalum capacitors can suffer catastrophic failure due to surge current when connected to a low-impedance source of power (like a battery or very large capacitor). If a Tantalum capacitor is used at the input, it must be specified by the manufacturer to have a surge current rating sufficient for the application.

There are no requirements for ESR on the input capacitor, but tolerance and temperature coefficient must be considered when selecting the capacitor to ensure the capacitance will be  $\geq$  1  $\mu$ F over the entire operating temperature range.

#### **Output Capacitor:**

The LP2992 is designed specifically to work with ceramic output capacitors, utilizing circuitry which allows the regulator to be stable across the entire range of output current with an output capacitor whose ESR is as low as  $5 \text{ m}\Omega$ . It may also be possible to use Tantalum or film capacitors at the output, but these are not as attractive for reasons of size and cost (see next section, CAPACITOR CHARACTERISTICS).

The output capacitor must meet the requirement for minimum amount of capacitance and also have an ESR (equivalent series resistance) value which is within the stable range. Curves are provided which show the stable ESR range as a function of load current (see ESR graph below).



**Important:** The output capacitor must maintain its ESR within the stable region over the full operating temperature range of the application to assure stability.

The LP2992 requires a minimum of 4.7 µF on the output (output capacitor size can be increased without limit).

It is important to remember that capacitor tolerance and variation with temperature must be taken into consideration when selecting an output capacitor so that the minimum required amount of output capacitance is provided over the full operating temperature range. It should be noted that ceramic capacitors can exhibit large changes in capacitance with temperature (see next section, CAPACITOR CHARACTERISTICS).

The output capacitor must be located not more than 1 cm from the output pin and returned to a clean analog ground.



#### **Noise Bypass Capacitor:**

Connecting a 10 nF capacitor to the Bypass pin significantly reduces noise on the regulator output. It should be noted that the capacitor is connected directly to a high-impedance circuit in the bandgap reference.

Because this circuit has only a few microamperes flowing in it, any significant loading on this node will cause a change in the regulated output voltage. For this reason, DC leakage current through the noise bypass capacitor must never exceed 100 nA, and should be kept as low as possible for best output voltage accuracy.

The types of capacitors best suited for the noise bypass capacitor are ceramic and film. High-quality ceramic capacitors with either NPO or COG dielectric typically have very low leakage. 10 nF polypropolene and polycarbonate film capacitors are available in small surface-mount packages and typically have extremely low leakage current.

#### **CAPACITOR CHARACTERISTICS**

The LP2992 was designed to work with ceramic capacitors on the output to take advantage of the benefits they offer: for capacitance values in the 2.2  $\mu F$  to 10  $\mu F$  range, ceramics are the least expensive and also have the lowest ESR values (which makes them best for eliminating high-frequency noise). The ESR of a typical 4.7  $\mu F$  ceramic capacitor is in the range of 5 m $\Omega$  to 10 m $\Omega$ , which easily meets the ESR limits required for stability by the LP2992.

One disadvantage of ceramic capacitors is that their capacitance can vary with temperature. Most large value ceramic capacitors (≥ 2.2 µF) are manufactured with the Z5U or Y5V temperature characteristic, which results in the capacitance dropping by more than 50% as the temperature goes from 25°C to 85°C.

This could cause problems if a 4.7  $\mu$ F capacitor were used on the output since it will drop down to approximately 2.3  $\mu$ F at high ambient temperatures (which could cause the LP2992 to oscillate). If Z5U or Y5V capacitors are used on the output, a minimum capacitance value of 10  $\mu$ F must be observed.

A better choice for temperature coefficient in ceramic capacitors is X7R, which holds the capacitance within ±15%. Unfortunately, the larger values of capacitance are not offered by all manufacturers in the X7R dielectric.

#### Tantalum:

Tantalum capacitors are less desirable than ceramics for use as output capacitors because they are more expensive when comparing equivalent capacitance and voltage ratings in the 1  $\mu$ F to 4.7  $\mu$ F range.

Another important consideration is that Tantalum capacitors have higher ESR values than equivalent size ceramics. This means that while it may be possible to find a Tantalum capacitor with an ESR value within the stable range, it would have to be larger in capacitance (which means bigger and more costly) than a ceramic capacitor with the same ESR value.

It should also be noted that the ESR of a typical Tantalum will increase about 2:1 as the temperature goes from 25°C down to −40°C, so some guard band must be allowed.

#### **ON/OFF INPUT OPERATION**

The LP2992 is shut off by driving the ON/OFF input low, and turned on by pulling it high. If this feature is not to be used, the ON/OFF input should be tied to  $V_{IN}$  to keep the regulator output on at all times.

To assure proper operation, the signal source used to drive the ON/OFF input must be able to swing above and below the specified turn-on/turn-off voltage thresholds listed in the Electrical Characteristics section under  $V_{ON/OFF}$ . To prevent mis-operation, the turn-on (and turn-off) voltage signals applied to the ON/OFF input must have a slew rate which is  $\geq$  40 mV/ $\mu$ s.

#### **CAUTION**

The regulator output voltage can not be ensured if a slow-moving AC (or DC) signal is applied that is in the range between the specified turn-on and turn-off voltages listed under the electrical specification  $V_{\text{ON/OFF}}$  (see Electrical Characteristics).



#### **REVERSE INPUT-OUTPUT VOLTAGE**

The PNP power transistor used as the pass element in the LP2992 has an inherent diode connected between the regulator output and input. During normal operation (where the input voltage is higher than the output) this diode is reverse-biased.

However, if the output is pulled above the input, this diode will turn ON and current will flow into the regulator output. In such cases, a parasitic SCR can latch which will allow a high current to flow into  $V_{IN}$  (and out the ground pin), which can damage the part.

In any application where the output may be pulled above the input, an external Schottky diode must be connected from  $V_{IN}$  to  $V_{OUT}$  (cathode on  $V_{IN}$ , anode on  $V_{OUT}$ ), to limit the reverse voltage across the LP2992 to 0.3V (see Absolute Maximum Ratings).

#### **WSON MOUNTING**

The WSON package requires specific mounting techniques which are detailed in Application Note # 1187 (literature number SNOA401). Referring to the section **PCB Design Recommendations**, it should be noted that the pad style which should be used with the WSON package is the NSMD (non-solder mask defined) type.

The thermal dissipation of the WSON package is directly related to the printed circuit board construction and the amount of additional copper area.

For the LP2992 in the NGD0006A 6-Lead WSON package, the junction-to-case thermal rating,  $\theta_{JC}$ , is 19°C/W, where the case is actually the bottom of the package at the center of the DAP. The junction-to-ambient thermal performance for the LP2992 in the NGD0006A 6-Lead WSON package, using the JEDEC standards is summarized in the following table:

Board Type	Thermal Vias	θ <sub>JC</sub>	$\theta_{JA}$
JEDEC 2–Layer	None	19°C/W	282°C/W
	1	19°C/W	94°C/W
JEDEC	2	19°C/W	78°C/W
4-Layer	4	19°C/W	66°C/W
	6	19°C/W	62°C/W

#### SNVS171G -NOVEMBER 2001-REVISED MARCH 2013



#### **REVISION HISTORY**

Cł	hanges from Revision F (March 2013) to Revision G	Pa	ıge
•	Changed layout of National Data Sheet to TI format		13





11-Apr-2013

#### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
LP2992AILD-1.5	ACTIVE	WSON	NGD	6	1000	TBD	Call TI	Call TI	-40 to 125	L011A	Samples
LP2992AILD-1.5/NOPB	ACTIVE	WSON	NGD	6	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L011A	Samples
LP2992AILD-1.8	ACTIVE	WSON	NGD	6	1000	TBD	Call TI	Call TI	-40 to 125	L012A	Samples
LP2992AILD-1.8/NOPB	ACTIVE	WSON	NGD	6	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L012A	Samples
LP2992AILD-3.3	ACTIVE	WSON	NGD	6	1000	TBD	Call TI	Call TI	-40 to 125	L014A	Samples
LP2992AILD-3.3/NOPB	ACTIVE	WSON	NGD	6	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L014A	Samples
LP2992AILD-5.0	ACTIVE	WSON	NGD	6	1000	TBD	Call TI	Call TI	-40 to 125	L015A	Samples
LP2992AILD-5.0/NOPB	ACTIVE	WSON	NGD	6	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L015A	Samples
LP2992AILDX-1.8	ACTIVE	WSON	NGD	6	4500	TBD	Call TI	Call TI	-40 to 125	L012A	Samples
LP2992AILDX-1.8/NOPB	ACTIVE	WSON	NGD	6	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L012A	Samples
LP2992AILDX-3.3	ACTIVE	WSON	NGD	6	4500	TBD	Call TI	Call TI	-40 to 125	L014A	Samples
LP2992AILDX-3.3/NOPB	ACTIVE	WSON	NGD	6	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L014A	Samples
LP2992AILDX-5.0	ACTIVE	WSON	NGD	6	4500	TBD	Call TI	Call TI	-40 to 125	L015A	Samples
LP2992AILDX-5.0/NOPB	ACTIVE	WSON	NGD	6	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L015A	Samples
LP2992AIM5-1.5	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFBA	Samples
LP2992AIM5-1.5/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFBA	Samples
LP2992AIM5-1.8	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFCA	Samples
LP2992AIM5-1.8/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFCA	Samples
LP2992AIM5-2.5	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFDA	Samples





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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
LP2992AIM5-2.5/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFDA	Samples
LP2992AIM5-3.3	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFEA	Samples
LP2992AIM5-3.3/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFEA	Samples
LP2992AIM5-5.0	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFFA	Samples
LP2992AIM5-5.0/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFFA	Samples
LP2992AIM5X-1.5	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFBA	Samples
LP2992AIM5X-1.5/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFBA	Samples
LP2992AIM5X-1.8	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFCA	Samples
LP2992AIM5X-1.8/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFCA	Samples
LP2992AIM5X-2.5	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFDA	Samples
LP2992AIM5X-2.5/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFDA	Samples
LP2992AIM5X-3.3	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFEA	Samples
LP2992AIM5X-3.3/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFEA	Samples
LP2992AIM5X-5.0	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFFA	Samples
LP2992AIM5X-5.0/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFFA	Samples
LP2992ILD-1.8	ACTIVE	WSON	NGD	6	1000	TBD	Call TI	Call TI	-40 to 125	L012A B	Samples
LP2992ILD-1.8/NOPB	ACTIVE	WSON	NGD	6	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L012A B	Samples
LP2992ILD-2.5	ACTIVE	WSON	NGD	6	1000	TBD	Call TI	Call TI	-40 to 125	L013A B	Samples
LP2992ILD-2.5/NOPB	ACTIVE	WSON	NGD	6	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L013A B	Samples





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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
LP2992ILD-3.3	ACTIVE	WSON	NGD	6	1000	TBD	Call TI	Call TI	-40 to 125	L014A B	Samples
LP2992ILD-3.3/NOPB	ACTIVE	WSON	NGD	6	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L014A B	Samples
LP2992ILD-5.0	ACTIVE	WSON	NGD	6	1000	TBD	Call TI	Call TI	-40 to 125	L015A B	Samples
LP2992ILD-5.0/NOPB	ACTIVE	WSON	NGD	6	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L015A B	Samples
LP2992ILDX-1.5	ACTIVE	WSON	NGD	6	4500	TBD	Call TI	Call TI	-40 to 125	L011A B	Samples
LP2992ILDX-1.5/NOPB	ACTIVE	WSON	NGD	6	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L011A B	Samples
LP2992ILDX-1.8	ACTIVE	WSON	NGD	6	4500	TBD	Call TI	Call TI	-40 to 125	L012A B	Samples
LP2992ILDX-1.8/NOPB	ACTIVE	WSON	NGD	6	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L012A B	Samples
LP2992ILDX-3.3	ACTIVE	WSON	NGD	6	4500	TBD	Call TI	Call TI	-40 to 125	L014A B	Samples
LP2992ILDX-3.3/NOPB	ACTIVE	WSON	NGD	6	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L014A B	Samples
LP2992ILDX-5.0	ACTIVE	WSON	NGD	6	4500	TBD	Call TI	Call TI	-40 to 125	L015A B	Samples
LP2992ILDX-5.0/NOPB	ACTIVE	WSON	NGD	6	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 125	L015A B	Samples
LP2992IM5-1.5	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFBB	Samples
LP2992IM5-1.5/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFBB	Samples
LP2992IM5-1.8	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFCB	Samples
LP2992IM5-1.8/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFCB	Samples
LP2992IM5-2.5	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFDB	Samples
LP2992IM5-2.5/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFDB	Samples





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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
LP2992IM5-3.0	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI		LF8B	Samples
LP2992IM5-3.0/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM		LF8B	Samples
LP2992IM5-3.3	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFEB	Samples
LP2992IM5-3.3/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFEB	Samples
LP2992IM5-5.0	ACTIVE	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LFFB	Samples
LP2992IM5-5.0/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFFB	Samples
LP2992IM5X-1.5	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFBB	Samples
LP2992IM5X-1.5/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFBB	Samples
LP2992IM5X-1.8	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFCB	Samples
LP2992IM5X-1.8/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFCB	Samples
LP2992IM5X-2.5	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFDB	Samples
LP2992IM5X-2.5/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFDB	Samples
LP2992IM5X-3.3	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFEB	Samples
LP2992IM5X-3.3/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFEB	Samples
LP2992IM5X-5.0	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125	LFFB	Samples
LP2992IM5X-5.0/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LFFB	Samples

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



#### PACKAGE OPTION ADDENDUM

11-Apr-2013

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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#### TAPE AND REEL INFORMATION



# TAPE DIMENSIONS KO P1 BO W Cavity A0

- 1		
	A0	Dimension designed to accommodate the component width
		Dimension designed to accommodate the component length
	K0	Dimension designed to accommodate the component thickness
	W	Overall width of the carrier tape
	D1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



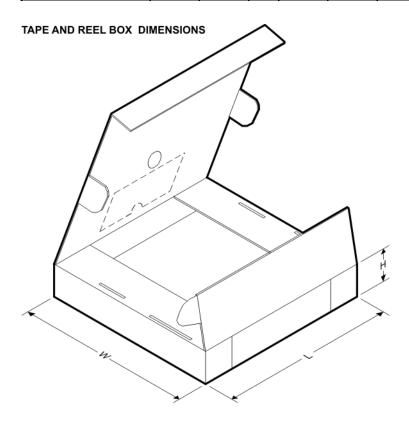
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2992AILD-1.5	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILD-1.5/NOPB	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILD-1.8	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILD-1.8/NOPB	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILD-3.3	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILD-3.3/NOPB	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILD-5.0	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILD-5.0/NOPB	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILDX-1.8	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILDX-1.8/NOPB	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILDX-3.3	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILDX-3.3/NOPB	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILDX-5.0	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AILDX-5.0/NOPB	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992AIM5-1.5	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5-1.5/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5-1.8	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5-1.8/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3



Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2992AIM5-2.5	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5-2.5/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5-3.3	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5-3.3/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5-5.0	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5-5.0/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-1.5	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-1.5/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-1.8	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-1.8/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-2.5	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-2.5/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-3.3	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-3.3/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-5.0	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992AIM5X-5.0/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992ILD-1.8	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILD-1.8/NOPB	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILD-2.5	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILD-2.5/NOPB	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILD-3.3	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILD-3.3/NOPB	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILD-5.0	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILD-5.0/NOPB	WSON	NGD	6	1000	178.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILDX-1.5	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILDX-1.5/NOPB	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILDX-1.8	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILDX-1.8/NOPB	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILDX-3.3	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILDX-3.3/NOPB	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILDX-5.0	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992ILDX-5.0/NOPB	WSON	NGD	6	4500	330.0	12.4	3.6	3.2	1.0	8.0	12.0	Q1
LP2992IM5-1.5	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-1.5/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-1.8	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-1.8/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-2.5	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-2.5/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-3.0	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-3.0/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-3.3	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-3.3/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5-5.0	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2992IM5-5.0/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-1.5	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-1.5/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-1.8	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-1.8/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-2.5	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-2.5/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-3.3	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-3.3/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-5.0	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2992IM5X-5.0/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2992AILD-1.5	WSON	NGD	6	1000	210.0	185.0	35.0
LP2992AILD-1.5/NOPB	WSON	NGD	6	1000	213.0	191.0	55.0
LP2992AILD-1.8	WSON	NGD	6	1000	210.0	185.0	35.0
LP2992AILD-1.8/NOPB	WSON	NGD	6	1000	213.0	191.0	55.0
LP2992AILD-3.3	WSON	NGD	6	1000	210.0	185.0	35.0
LP2992AILD-3.3/NOPB	WSON	NGD	6	1000	213.0	191.0	55.0



Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
						` ,	
LP2992AILD-5.0	WSON	NGD	6	1000	210.0	185.0	35.0
LP2992AILD-5.0/NOPB	WSON	NGD	6	1000	213.0	191.0	55.0
LP2992AILDX-1.8	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992AILDX-1.8/NOPB	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992AILDX-3.3	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992AILDX-3.3/NOPB	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992AILDX-5.0	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992AILDX-5.0/NOPB	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992AIM5-1.5	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-1.5/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-1.8	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-1.8/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-2.5	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-2.5/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-3.3	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-3.3/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-5.0	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5-5.0/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992AIM5X-1.5	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-1.5/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-1.8	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-1.8/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-2.5	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-2.5/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-3.3	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-3.3/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-5.0	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992AIM5X-5.0/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992ILD-1.8	WSON	NGD	6	1000	210.0	185.0	35.0
LP2992ILD-1.8/NOPB	WSON	NGD	6	1000	213.0	191.0	55.0
LP2992ILD-2.5	WSON	NGD	6	1000	210.0	185.0	35.0
LP2992ILD-2.5/NOPB	WSON	NGD	6	1000	213.0	191.0	55.0
LP2992ILD-3.3	WSON	NGD	6	1000	210.0	185.0	35.0
LP2992ILD-3.3/NOPB	WSON	NGD	6	1000	213.0	191.0	55.0
LP2992ILD-5.0	WSON	NGD	6	1000	210.0	185.0	35.0
LP2992ILD-5.0/NOPB	WSON	NGD	6	1000	213.0	191.0	55.0
LP2992ILDX-1.5	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992ILDX-1.5/NOPB	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992ILDX-1.8	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992ILDX-1.8/NOPB	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992ILDX-3.3	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992ILDX-3.3/NOPB	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992ILDX-5.0	WSON	NGD	6	4500	367.0	367.0	35.0
LP2992ILDX-5.0/NOPB	WSON	NGD	6	4500	367.0	367.0	35.0



Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2992IM5-1.5	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-1.5/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-1.8	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-1.8/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-2.5	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-2.5/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-3.0	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-3.0/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-3.3	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-3.3/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-5.0	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5-5.0/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2992IM5X-1.5	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-1.5/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-1.8	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-1.8/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-2.5	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-2.5/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-3.3	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-3.3/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-5.0	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2992IM5X-5.0/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0

# DBV (R-PDSO-G5)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-178 Variation AA.



# DBV (R-PDSO-G5)

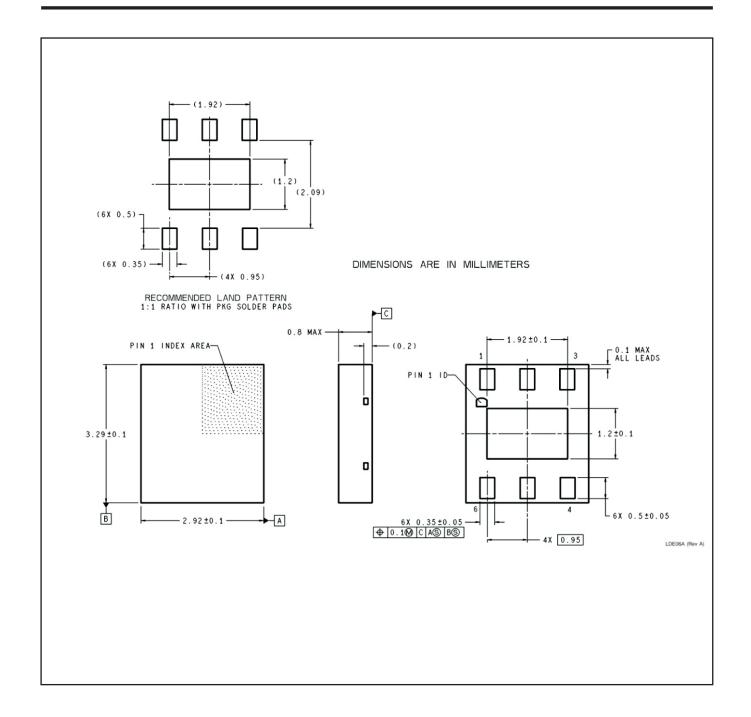
# PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.





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